## Supporting Information

## Improved Resistive Switching Characteristics of multi-stacked HfO<sub>2</sub>/Al<sub>2</sub>O<sub>3</sub>/HfO<sub>2</sub> RRAM structure for neuromorphic and synaptic applications: Experimental and Computational study

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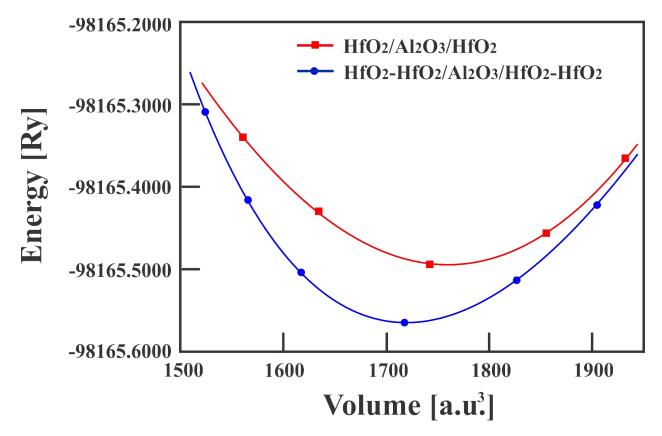


Figure S1. The geometry optimized Energy vs. Volume plots using Birch Murnaghan equation of states.

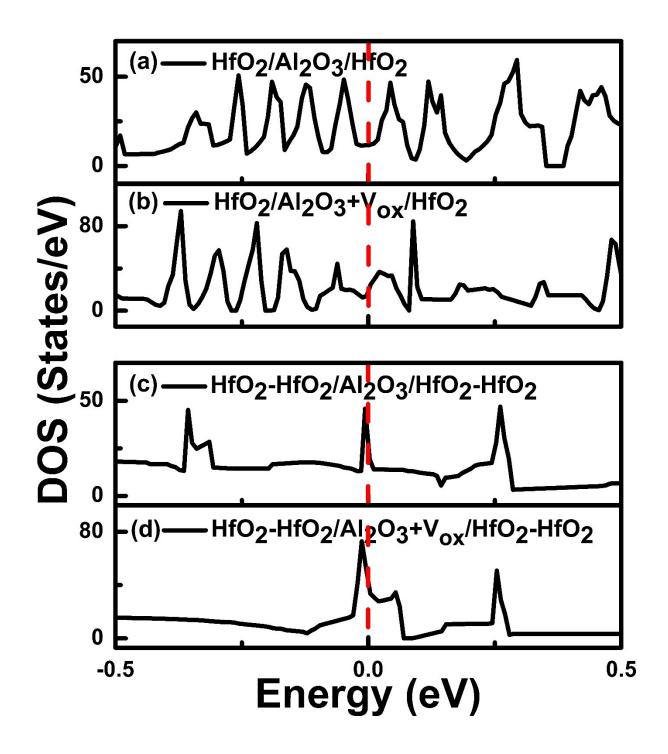


Figure S2. The calculated Density of States (DOS) using VASP simulation code.